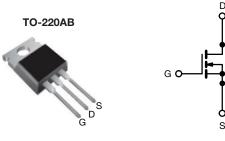
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.097			
Q _g max. (nC)	140				
Q _{gs} (nC)	22				
Q _{gd} (nC)	38				
Configuration	Single				



S

N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and Halogen-free	SiHP28N65E-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	650	v	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Querent (T. 150 °C)	$T_{\rm C} = 2$	T _C = 25 °C T _C = 100 °C		29		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	V _{GS} at 10 V	$T_C = 100 \ ^\circ C$		18	А	
Pulsed Drain Current ^a			I _{DM}	87		
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	427	mJ	
Maximum Power Dissipation			PD	250	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		70			
Reverse Diode dV/dt ^d			dV/dt	21	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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RoHS COMPLIANT HALOGEN FREE

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PARAMETER	SYMBOL	TYP.	M	XX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	6	62			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.5		.5	°C/W		
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)					
PARAMETER	SYMBOL	1	CONDITIONS	MIN.	TYP.	MAX.	UNI
Static					I		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _D = 1 mA	-	0.80	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D = 250 μA	2	-	4	V
	0.0(0.1)		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
			= 650 V, V _{GS} = 0 V	-	-	1	μ/
Zero Gate Voltage Drain Current	I _{DSS}	-	^v , V _{GS} = 0 V, T _J = 125 °C	- (-	25	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 14 A	-	0.097	0.112	Ω
Forward Transconductance	g _{fs}	V _{DS}	= 30 V, I _D = 14 A	-	9	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$		-	3405	-	
Output Capacitance	C _{oss}			-	160	-	-
Reverse Transfer Capacitance	C _{rss}			-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0$ V to 520 V, $V_{GS} = 0$ V		-	106	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	430	-	1
Total Gate Charge	Qg		V _{GS} = 10 V I _D = 14 A, V _{DS} = 520 V		93	140	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$			22	-	
Gate-Drain Charge	Q _{gd}			-	38	-	
Turn-On Delay Time	t _{d(on)}			-	28	56	
Rise Time	t _r	Vee -	520 V In = 14 A	-	42	84	
Turn-Off Delay Time	t _{d(off)}	V_{DD} = 520 V, I _D = 14 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	88	132	ns
Fall Time	t _f			-	45	90	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	-						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	A
Pulsed Diode Forward Current	I _{SM}			-	-	87	~
Diode Forward Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 14 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	– –		-	483	966	ns
Reverse Recovery Charge	Q _{rr}	$T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 14 \text{ A,}$ dI/dt = 100 A/ μ s ^{, V} _R = 25 V		-	8	16	μC
Reverse Recovery Current	I _{RRM}			_	28	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

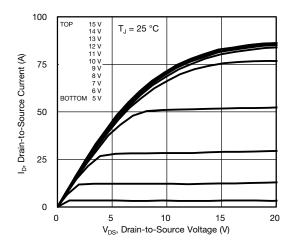


Fig. 1 - Typical Output Characteristics

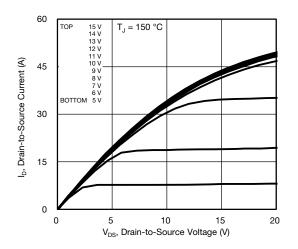


Fig. 2 - Typical Output Characteristics

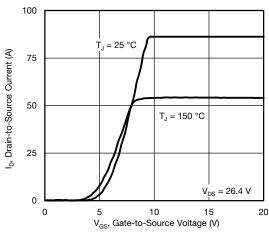


Fig. 3 - Typical Transfer Characteristics

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3 For technical questions, contact: <u>hvm@vishay.com</u>

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3.0 = 14 A R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.5 1.0 10 \ GS 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

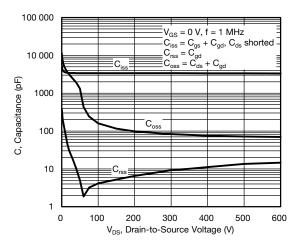
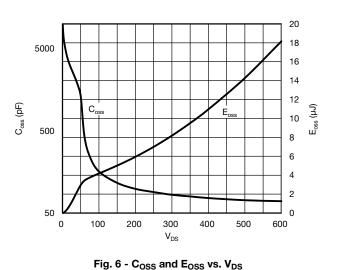


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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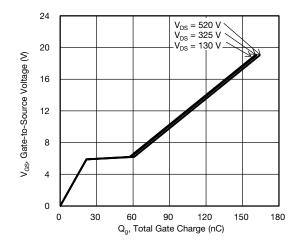


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

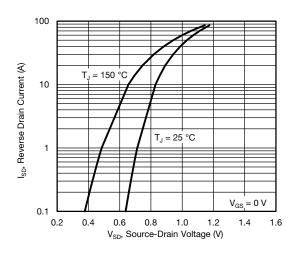


Fig. 8 - Typical Source-Drain Diode Forward Voltage

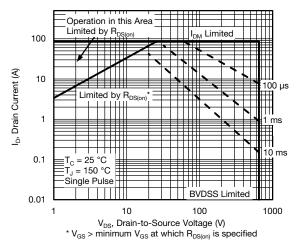


Fig. 9 - Maximum Safe Operating Area

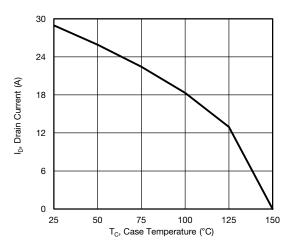


Fig. 10 - Maximum Drain Current vs. Case Temperature

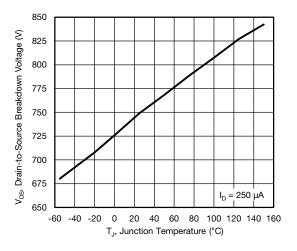
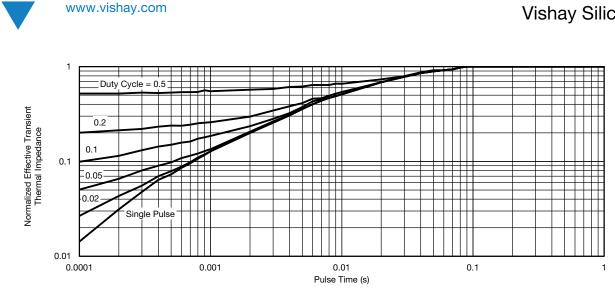


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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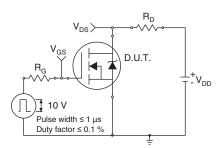


Fig. 13 - Switching Time Test Circuit

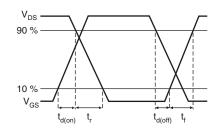


Fig. 14 - Switching Time Waveforms

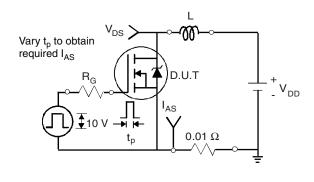


Fig. 15 - Unclamped Inductive Test Circuit

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V_{DS} V_{DD} V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

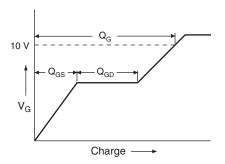
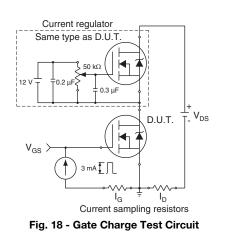


Fig. 17 - Basic Gate Charge Waveform



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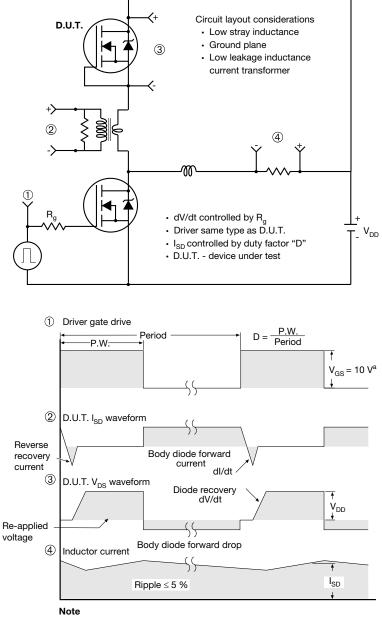
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

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